



STP25NM60N - STF25NM60N STB25NM60N/-1 - STW25NM60N

N-CHANNEL 600V 0.140Ω-20A TO-220/FP/D²/I²PAK/TO-247
SECOND GENERATION MDmesh™ MOSFET

PRODUCT PREVIEW

Table 1: General Features

TYPE	V _{DSS} (@T _{jmax})	R _{D(on)}	I _D
STB25NM60N-1	650 V	< 0.170 Ω	20 A
STF25NM60N	650 V	< 0.170 Ω	20(*) A
STP25NM60N	650 V	< 0.170 Ω	20 A
STW25NM60N	650 V	< 0.170 Ω	20 A
STB25NM60N	650 V	< 0.170 Ω	20 A

- WORLD'S LOWEST ON RESISTANCE
- TYPICAL R_{D(on)} = 0.140 Ω
- HIGH dv/dt AND AVALANCHE CAPABILITIES
- 100% AVALANCHE TESTED
- LOW INPUT CAPACITANCE AND GATE CHARGE
- LOW GATE INPUT RESISTANCE

DESCRIPTION

The **STP25NM60N** is realized with the second generation of MDmesh Technology. This revolutionary MOSFET associates a new vertical structure to the Company's strip layout to yield the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters

APPLICATIONS

The MDmesh™ II family is very suitable for increase the power density of high voltage converters allowing system miniaturization and higher efficiencies.

Table 2: Order Code

SALES TYPE	MARKING	PACKAGE	PACKAGING
STB25NM60N-1	B25NM60N	I ² PAK	TUBE
STF25NM60N	F25NM60N	TO-220FP	TUBE
STP25NM60N	P25NM60N	TO-220	TUBE
STW25NM60N	W25NM60N	TO-247	TUBE
STB25NM60N	B25NM60N	D ² PAK	TAPE & REEL

Figure 1: Package

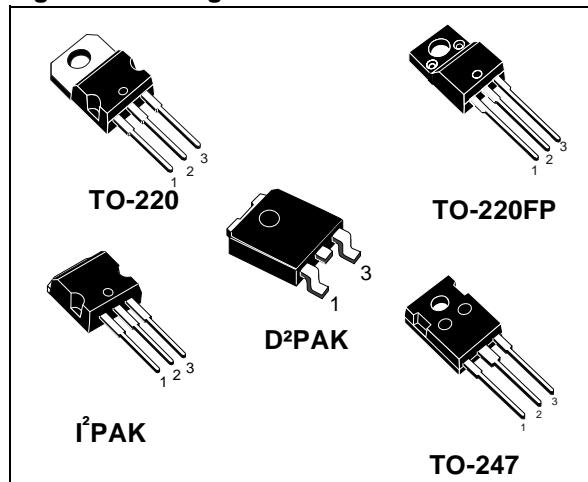
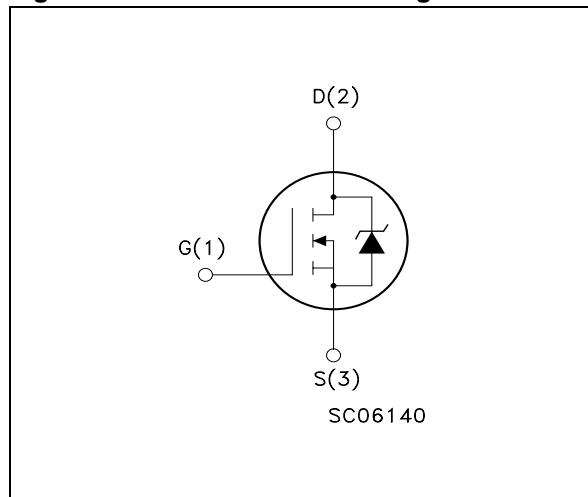


Figure 2: Internal Schematic Diagram



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Table 3: Absolute Maximum ratings

Symbol	Parameter	Value		Unit
		TO-220/I ² PAK TO-247/D ² PAK		TO-220FP
V _{DS}	Drain-source Voltage (V _{GS} = 0)	600		V
V _{DGR}	Drain-gate Voltage (R _{GS} = 20 kΩ)	600		V
V _{GS}	Gate- source Voltage	± 25		V
I _D	Drain Current (continuous) at T _C = 25°C	20	20 (*)	A
I _D	Drain Current (continuous) at T _C = 100°C	12.8	12.8 (*)	A
I _{DM} (1)	Drain Current (pulsed)	80	80 (*)	A
P _{TOT}	Total Dissipation at T _C = 25°C	160	40	W
	Derating Factor	1.28	0.32	W/°C
dv/dt (2)	Peak Diode Recovery voltage slope	TBD		V/ns
T _{stg}	Storage Temperature	– 55 to 150		°C
T _j	Max. Operating Junction Temperature	150		°C

(*) Limited only by maximum temperature allowed

(1) Pulse width limited by safe operating area

(2) I_{SD} ≤ 20 A, di/dt ≤ 400 A/μs, V_{DD} = 80%V_{(BR)DSS}.

Table 4: Thermal Data

		TO-220/I ² PAK TO-247/D ² PAK	TO-220FP	
R _{thj-case}	Thermal Resistance Junction-case Max	0.78	3.1	°C/W
R _{thj-amb}	Thermal Resistance Junction-ambient Max	62.5		°C/W
T _I	Maximum Lead Temperature For Soldering Purpose	300		°C

Table 5: Avalanche Characteristics

Symbol	Parameter	Max Value		Unit
I _{AS}	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T _j max)	TBD		A
E _{AS}	Single Pulse Avalanche Energy (starting T _j = 25 °C, I _D = I _{AS} , V _{DD} = 50 V)	TBD		mJ

ELECTRICAL CHARACTERISTICS (T_{CASE} = 25°C UNLESS OTHERWISE SPECIFIED)

Table 6: On /Off

Symbol	Parameter	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
V _{(BR)DSS}	Drain-source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0	600			V
dv/dt(2)	Drain Source Voltage Slope	V _{DD} =TBD, I _D =TBD, V _{Gs} =TBD	TBD			V/ns
I _{DSS}	Zero Gate Voltage Drain Current (V _{GS} = 0)	V _{DS} = Max Rating V _{DS} = Max Rating, T _C = 125°C			1 10	μA μA
I _{GSS}	Gate-body Leakage Current (V _{DS} = 0)	V _{GS} = ± 20 V			100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2	3	4	V
R _{DS(on)}	Static Drain-source On Resistance	V _{GS} = 10 V, I _D = 10 A		0.140	0.170	Ω

(2) Characteristic value at turn off on inductive load

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ELECTRICAL CHARACTERISTICS (CONTINUED)

Table 7: Dynamic

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
g_{fs} (1)	Forward Transconductance	$V_{DS} = 15V$, $I_D = 10A$		17		S
C_{iss} C_{oss} C_{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25 V$, $f = 1 MHz$, $V_{GS} = 0$		2565 511 77		pF pF pF
$C_{OSS\ eq}$ (3)	Equivalent Output Capacitance	$V_{GS} = 0 V$, $V_{DS} = 0$ to 480 V		TBD		pF
R_G	Gate Input Resistance	$f=1 MHz$ Gate DC Bias = 0 Test Signal Level = 20mV Open Drain		2		Ω
$t_{d(on)}$ t_r $t_{d(off)}$ t_f	Turn-on Delay Time Rise Time Turn-off-Delay Time Fall Time	$V_{DD} = 300 V$, $I_D = 10 A$, $R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 4)		TBD TBD TBD TBD		ns ns ns ns
Q_g Q_{gs} Q_{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	$V_{DD} = 480 V$, $I_D = 20 A$, $V_{GS} = 10 V$ (see Figure 7)		93 TBD TBD		nC nC nC

Table 8: Source Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{SD} I_{SDM} (2)	Source-drain Current Source-drain Current (pulsed)				20 80	A A
V_{SD} (1)	Forward On Voltage	$I_{SD} = 20 A$, $V_{GS} = 0$			1.3	V
t_{rr} Q_{rr} I_{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$I_{SD} = 25 A$, $di/dt = 100 A/\mu s$ $V_{DD} = 100V$ (see Figure 5)		TBD TBD TBD		ns μC A
t_{rr} Q_{rr} I_{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$I_{SD} = 25 A$, $di/dt = 100 A/\mu s$ $V_{DD} = 100V$, $T_j = 150^\circ C$ (see Figure 5)		TBD TBD TBD		ns μC A

(1) Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %.

(2) Pulse width limited by safe operating area.

(3) $C_{OSS\ eq}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

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Figure 3: Unclamped Inductive Load Test Circuit

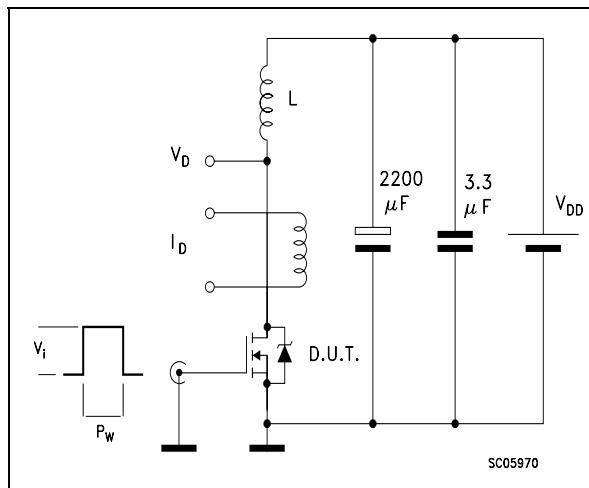


Figure 4: Switching Times Test Circuit For Resistive Load

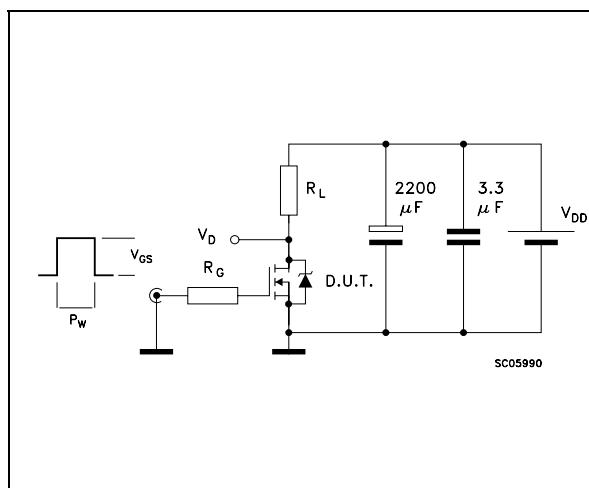


Figure 5: Test Circuit For Inductive Load Switching and Diode Recovery Times

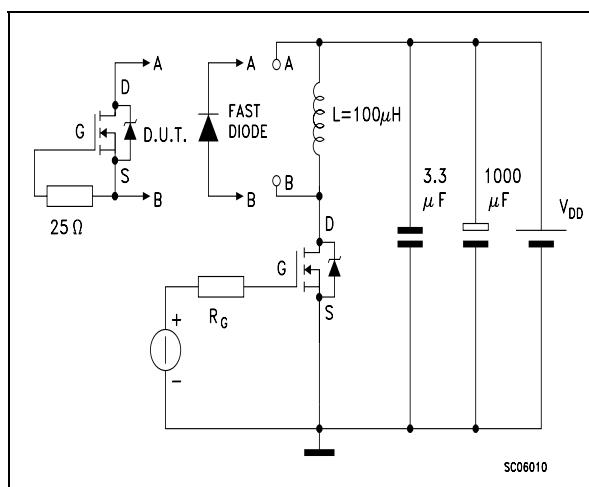


Figure 6: Unclamped Inductive Waveform

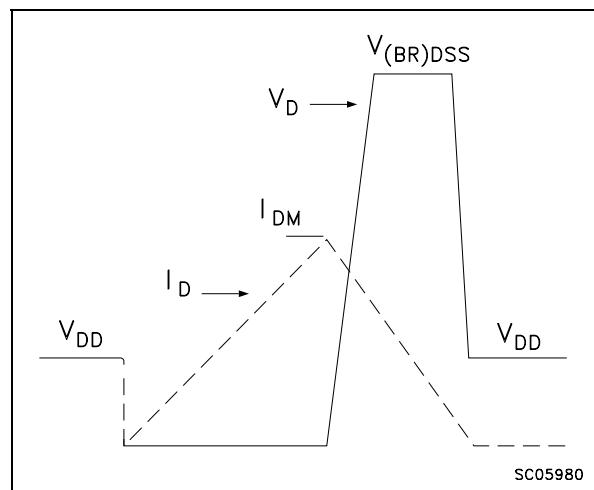
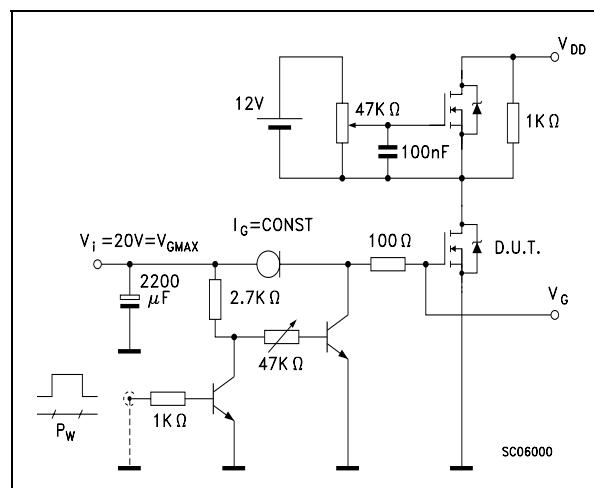


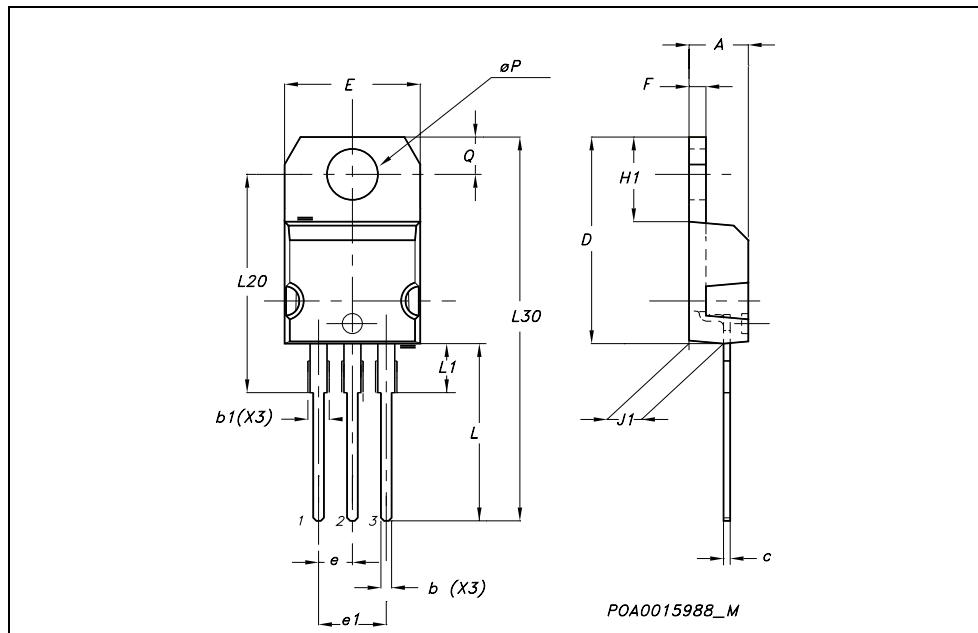
Figure 7: Gate Charge Test Circuit



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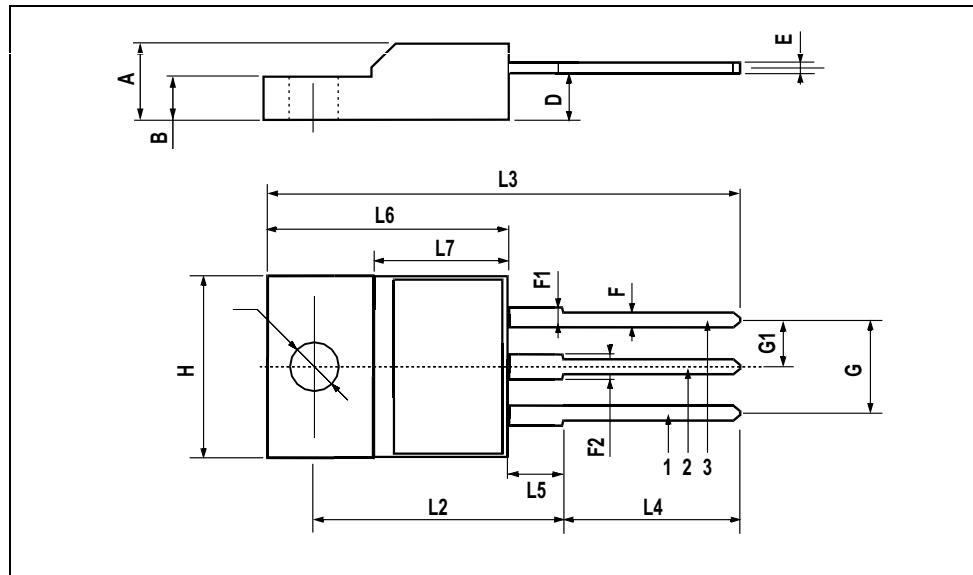
TO-220 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.15		1.70	0.045		0.066
c	0.49		0.70	0.019		0.027
D	15.25		15.75	0.60		0.620
E	10		10.40	0.393		0.409
e	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
øP	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



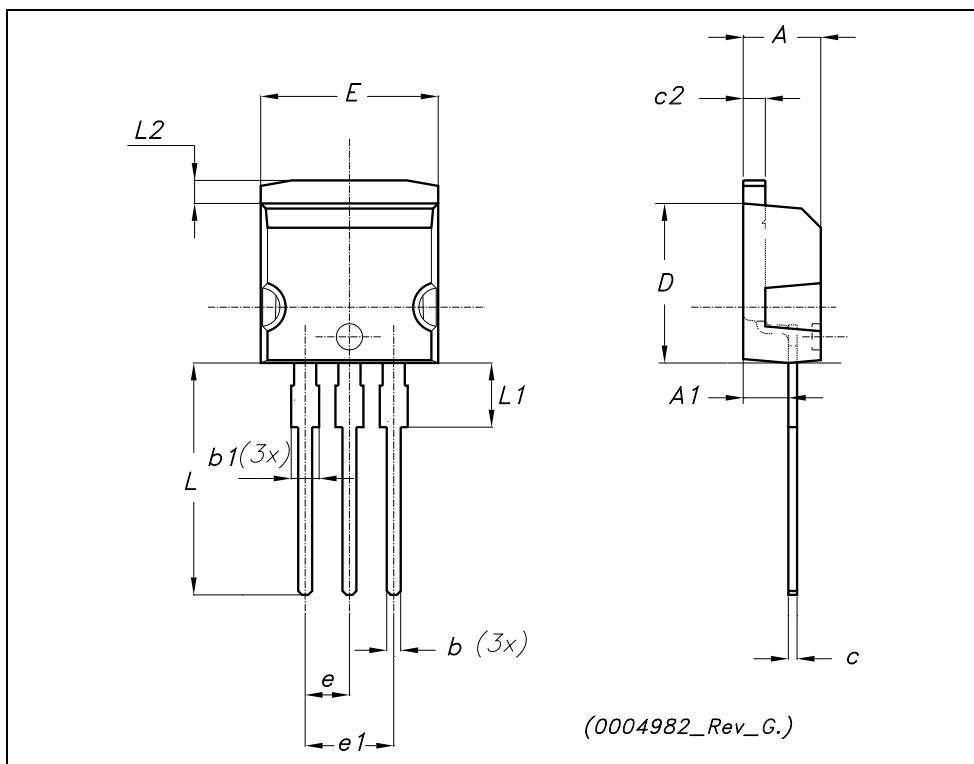
TO-220FP MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.4		4.6	0.173		0.181
B	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
H	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	.0385		0.417
L5	2.9		3.6	0.114		0.141
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126



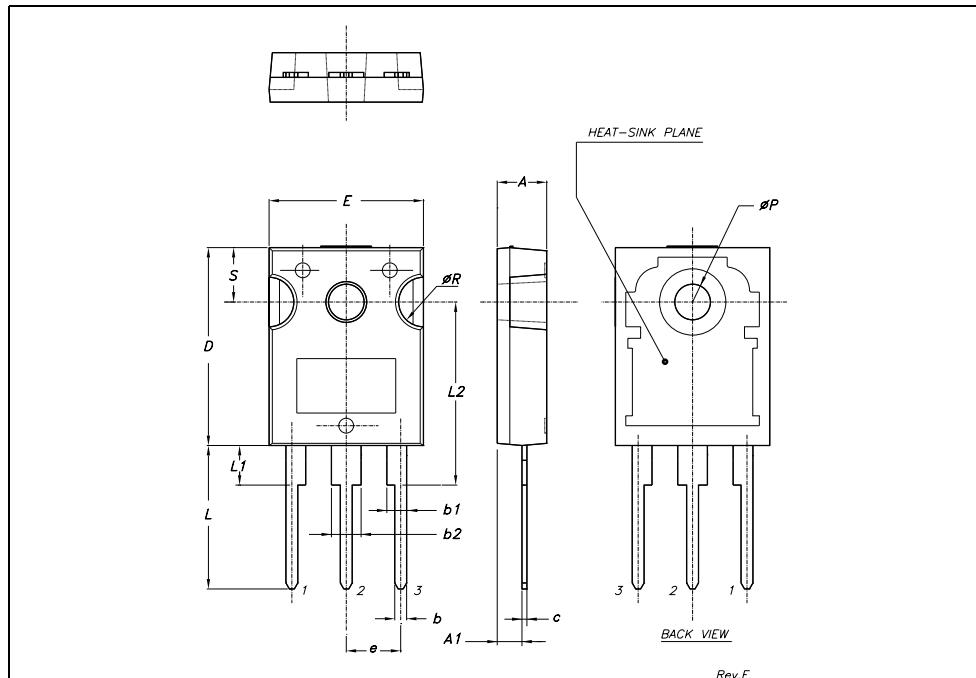
TO-262 (I²PAK) MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.40		4.60	0.173		0.181
A1	2.40		2.72	0.094		0.107
b	0.61		0.88	0.024		0.034
b1	1.14		1.70	0.044		0.066
c	0.49		0.70	0.019		0.027
c2	1.23		1.32	0.048		0.052
D	8.95		9.35	0.352		0.368
e	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
E	10		10.40	0.393		0.410
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L2	1.27		1.40	0.050		0.055



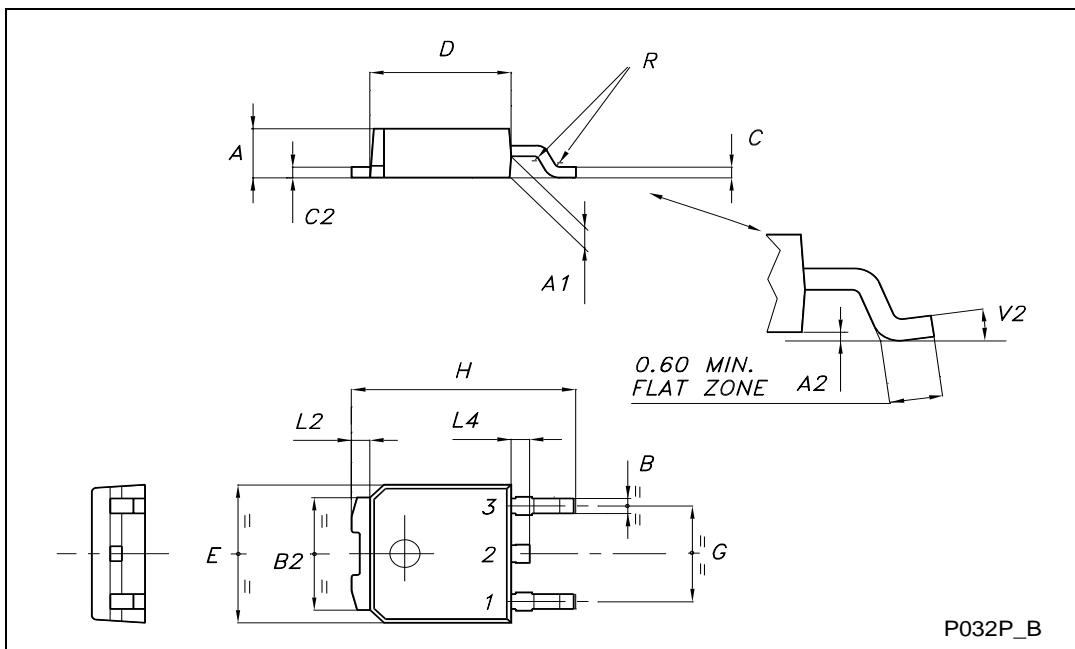
TO-247 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
c	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
E	15.45		15.75	0.608		0.620
e		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
ϕP	3.55		3.65	0.140		0.143
ϕR	4.50		5.50	0.177		0.216
S		5.50			0.216	

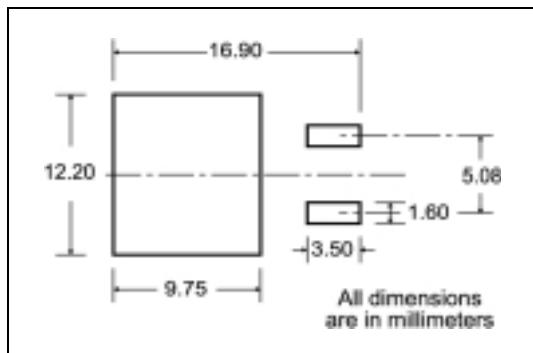


TO-252 (DPAK) MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	2.20		2.40	0.087		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
B	0.64		0.90	0.025		0.035
B2	5.20		5.40	0.204		0.213
C	0.45		0.60	0.018		0.024
C2	0.48		0.60	0.019		0.024
D	6.00		6.20	0.236		0.244
E	6.40		6.60	0.252		0.260
G	4.40		4.60	0.173		0.181
H	9.35		10.10	0.368		0.398
L2		0.8			0.031	
L4	0.60		1.00	0.024		0.039
V2	0°		8°	0°		0°



D²PAK FOOTPRINT



TAPE AND REEL SHIPMENT

REEL MECHANICAL DATA				
DIM.	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A		330		12.992
B	1.5		0.059	
C	12.8	13.2	0.504	0.520
D	20.2		0795	
G	24.4	26.4	0.960	1.039
N	100		3.937	
T		30.4		1.197

BASE QTY	BULK QTY
1000	1000

40 mm min.
Access hole at slot location
Full radius
Tape slot in core for tape start
2.5mm min. width

TAPE MECHANICAL DATA

DIM.	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A0	10.5	10.7	0.413	0.421
B0	15.7	15.9	0.618	0.626
D	1.5	1.6	0.059	0.063
D1	1.59	1.61	0.062	0.063
E	1.65	1.85	0.065	0.073
F	11.4	11.6	0.449	0.456
K0	4.8	5.0	0.189	0.197
P0	3.9	4.1	0.153	0.161
P1	11.9	12.1	0.468	0.476
P2	1.9	2.1	0.075	0.082
R	50		1.574	
T	0.25	0.35	0.0098	0.0137
W	23.7	24.3	0.933	0.956

User Direction of Feed

TRL

FEED DIRECTION →

Bending radius R min.

* on sales type

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Table 9: Revision History

Date	Revision	Description of Changes
30-Nov-2004	1	First Release.
22-Mar-2005	2	Modified title
23-May-2005	3	Inserted some values in Tab7
08-Jun-2005	4	Inserted new row in table 6

STP25NM60N - STF25NM60N - STB25NM60N/-1 - STW25NM60N

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